

## Supporting Information

# Toward Real-time Monitoring Lithium Metal Growth and Early Dendrite Formation Surveillance for Safe Lithium Metal Batteries

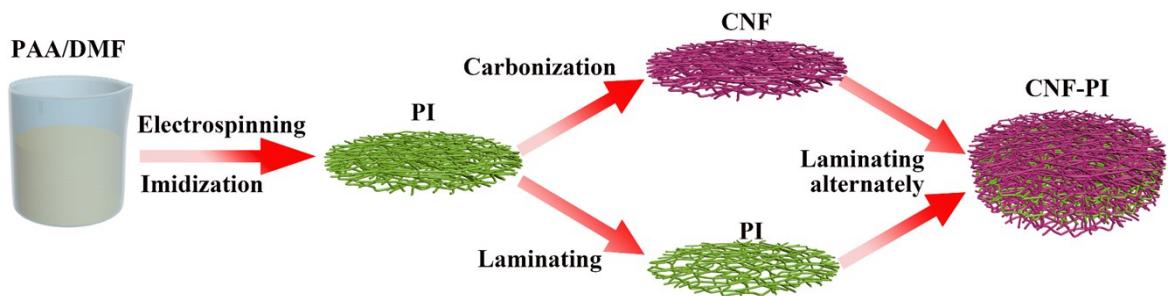
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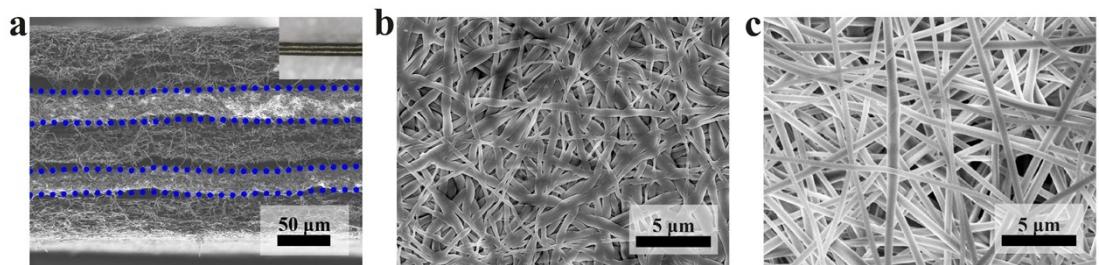
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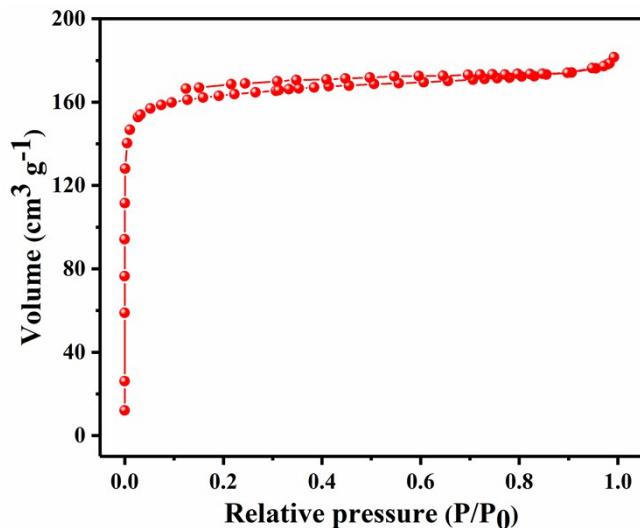
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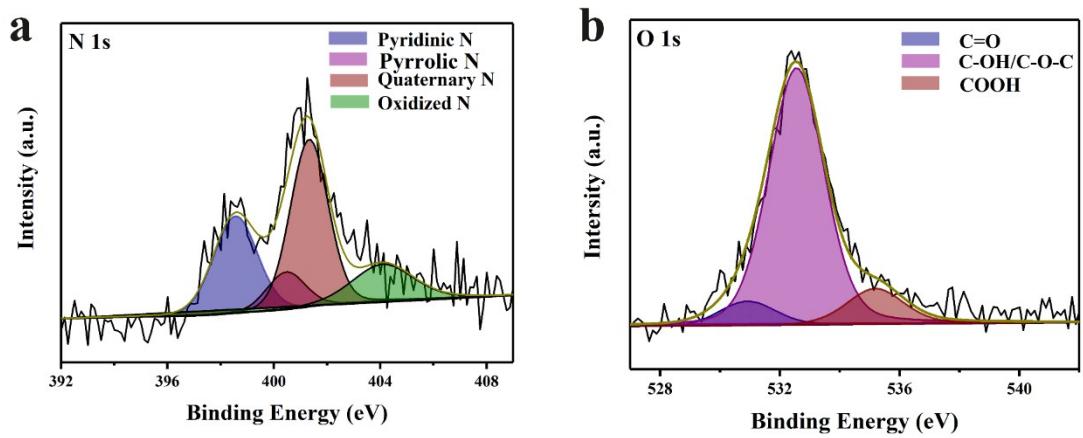
**Fig. S1.** Schematic diagram of the fabrication process of the CNF-PI host.



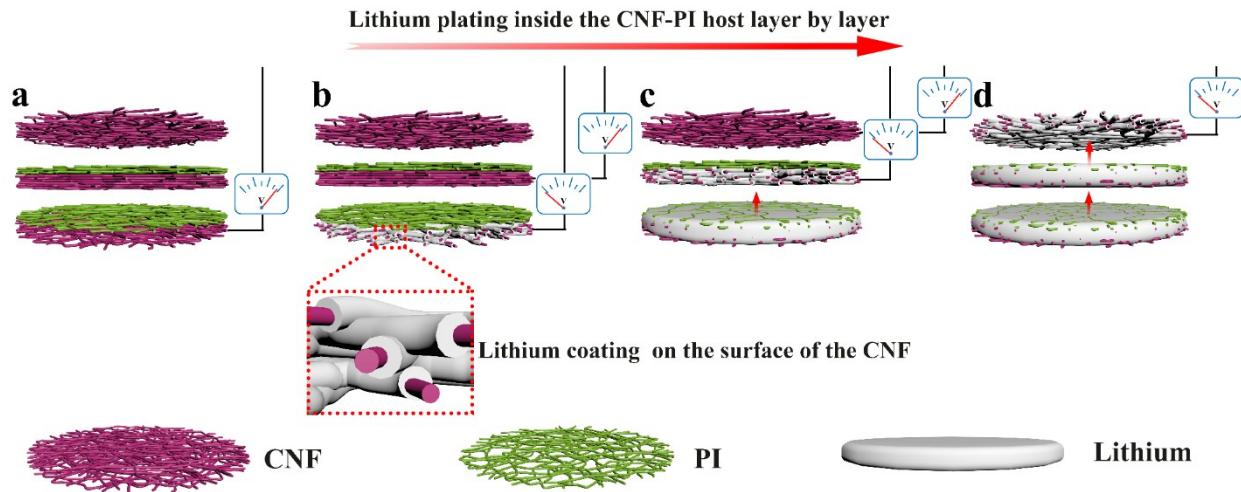
**Fig. S2.** SEM images of (a) Cross-sectional SEM image of CNF-PI 3D host, (b) PI films after laminating and (c) CNF scaffold. Inset panel in (a) is digital photograph of CNF-PI.



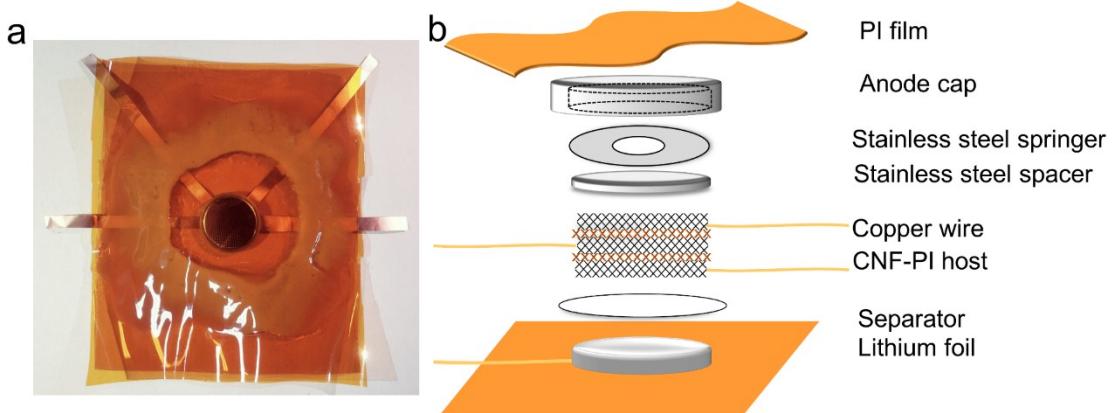
**Fig. S3.** Nitrogen adsorption-desorption isotherm of CNF.



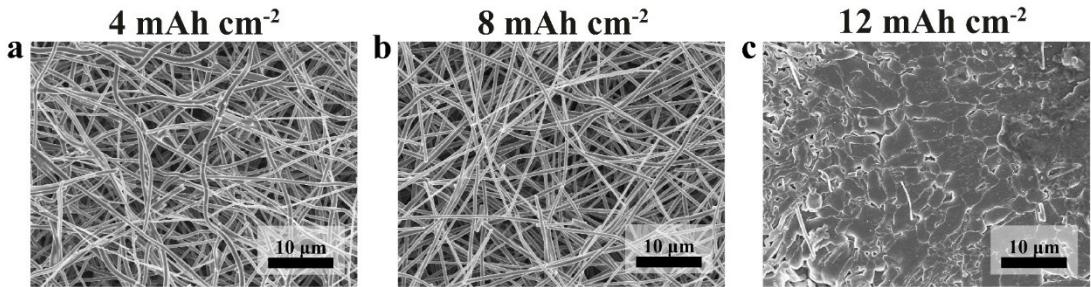
**Fig. S4.** (a) N 1s and (b) O 1s high-resolution XPS spectra for CNF.



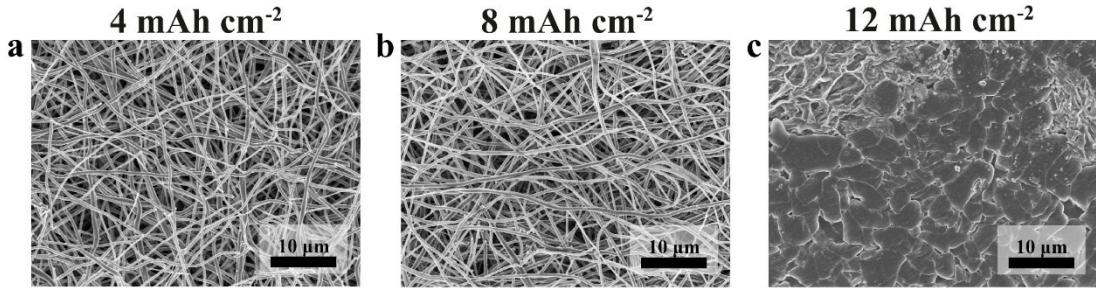
**Fig. S5.** Schematic illustration of the lithium plating process inside the CNF-PI host. Lithium metal grows in a stepwise "bottom-up" manner due to the block of the electronic transport path.



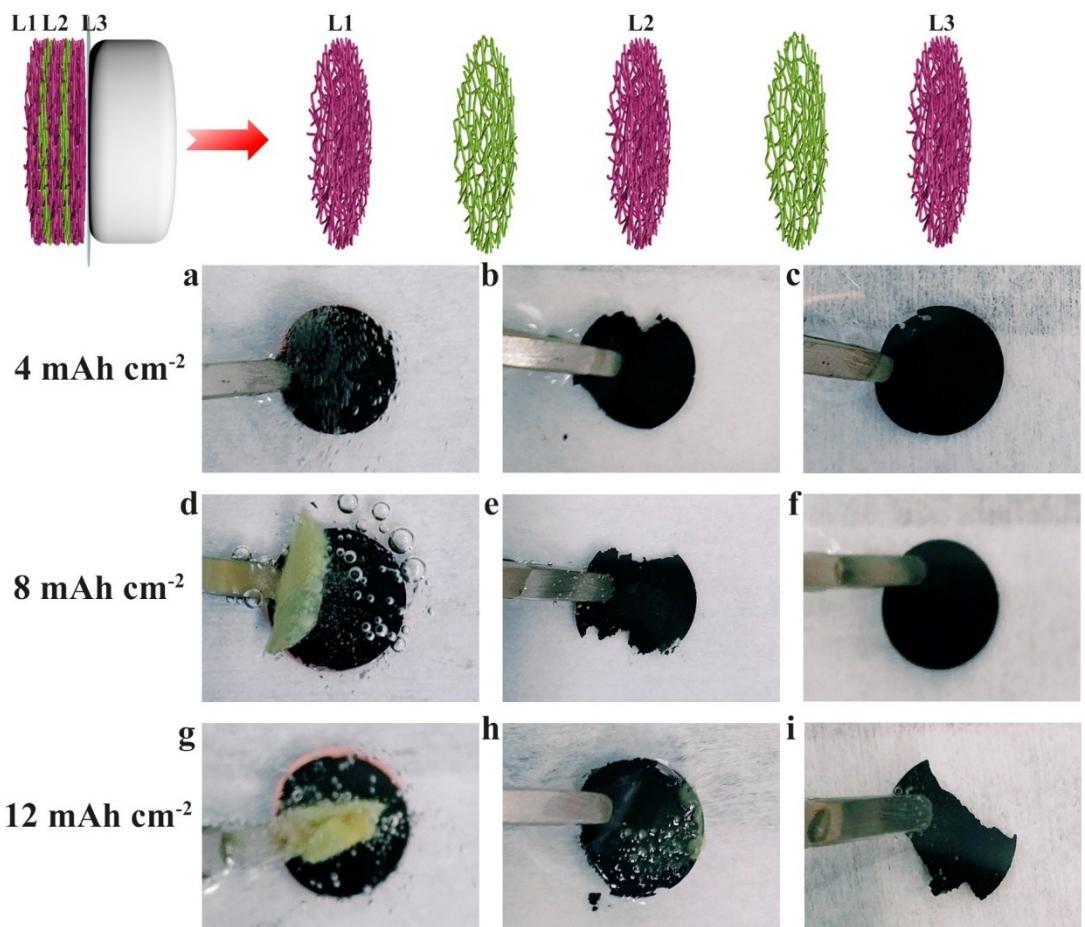
**Fig. S6.** (a) Digital photos of the voltage monitoring cell and (b) the schematic illustration of its inside structure. Three copper wire terminals link separately three layers of CNF in the CNF-PI host to monitor the voltage. The anode cap and stainless-steel springer/spacer are assembled to fix the cell and release the packaging stress.



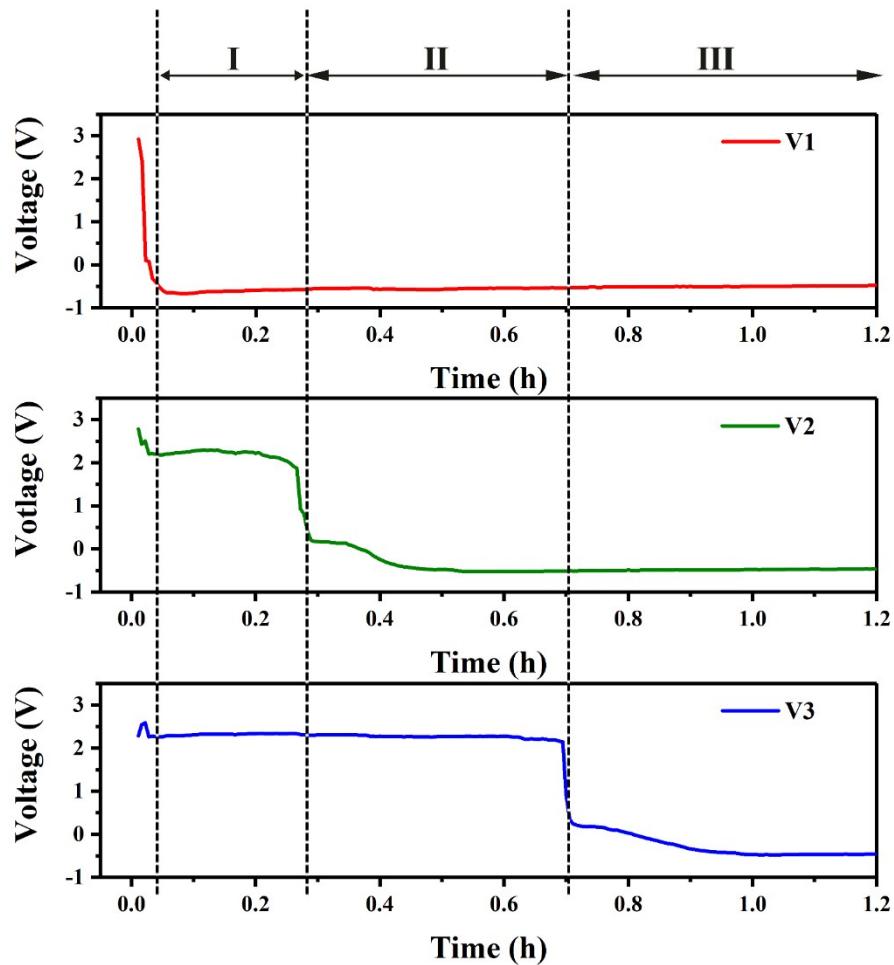
**Fig. S7.** (a-c) SEM images of the CNF-PI host when (a)  $4 \text{ mAh cm}^{-2}$ , (b)  $8 \text{ mAh cm}^{-2}$ , (c)  $12 \text{ mAh cm}^{-2}$  lithium was plated in. Only carbon nanofibers are observed on the surface until the lithium deposition capacity increasing to  $12 \text{ mAh cm}^{-2}$ .



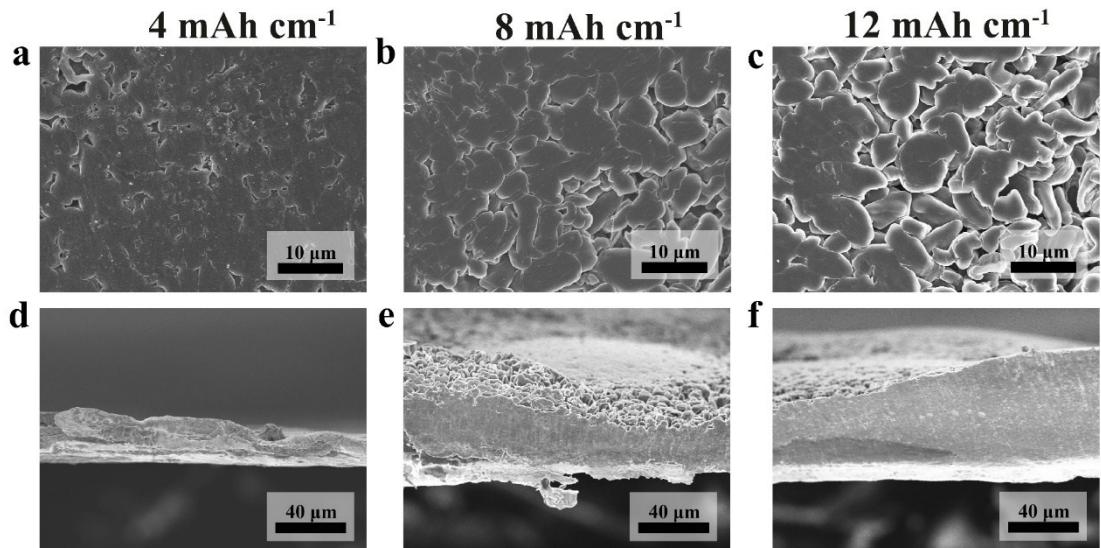
**Fig. S8.** (a-c) SEM images of lithium depositing inside the CNF-PI host after 10 cycles at  $1 \text{ mA cm}^{-2}$  and (b)  $4 \text{ mAh cm}^{-2}$ , (b)  $8 \text{ mAh cm}^{-2}$ , (c)  $12 \text{ mAh cm}^{-2}$ .



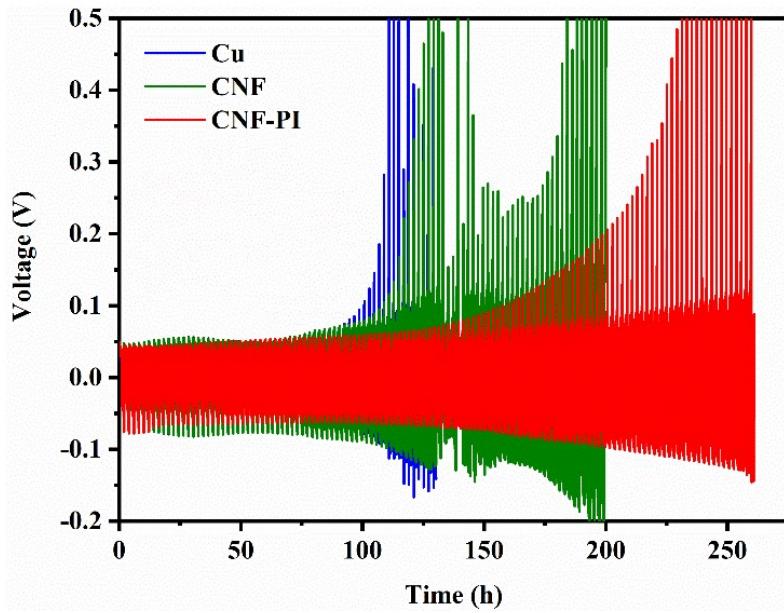
**Fig. S9.** CNF-PI host with (a, b, c) 4 mAh cm<sup>-2</sup>, (d, e, f) 8 mAh cm<sup>-2</sup>, (a, h, i) 12 mAh cm<sup>-2</sup> lithium deposition was separated, and the (a, d, g) bottom, (b, e, g) intermediate, (c, f, i) top layer of CNF was dipped in water-alcohol mix solution. Bubbles generating at different lithium plating capacity confirm the stepwise deposition of lithium metal layer by layer inside the CNF-PI framework and the change in the monitoring voltage of the conductive layer reflecting the location of the lithium metal.



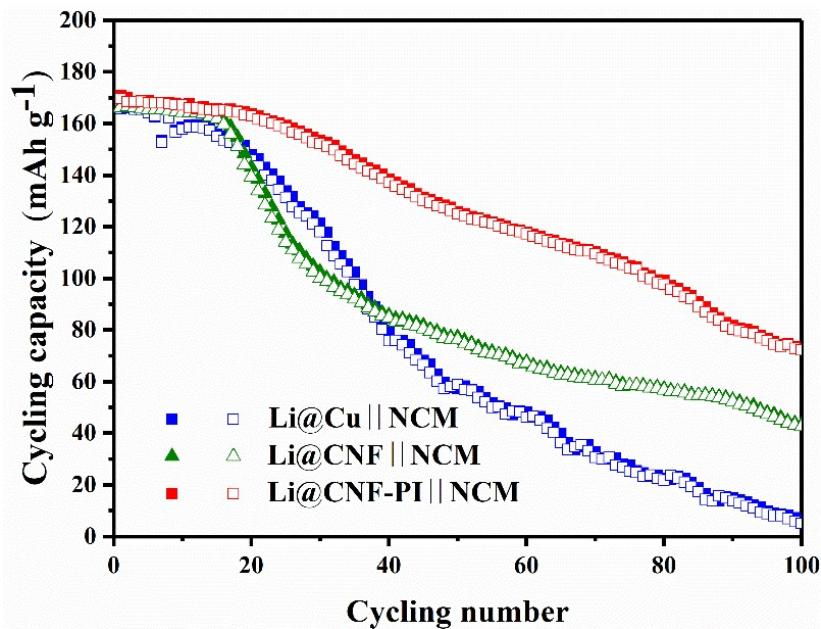
**Fig. S10.** Voltage profile of three layers of CNF monitoring voltage V1, V2 and V3 when a current of  $10 \text{ mA cm}^{-2}$  was applied.



**Fig. S11.** (a-c) SEM images of lithium depositing on the Cu host when (a)  $4 \text{ mAh cm}^{-2}$ , (b)  $8 \text{ mAh cm}^{-2}$ , (c)  $12 \text{ mAh cm}^{-2}$  lithium was plated in. (d-f) Cross-sectional SEM images of lithium depositing on the Cu host when (d)  $4 \text{ mAh cm}^{-2}$ , (e)  $8 \text{ mAh cm}^{-2}$ , (f)  $12 \text{ mAh cm}^{-2}$  lithium was plated in.



**Fig. S12.** Voltage-time profile of the half cells (Cu||Li, CNF||Li, CNF-PI||Li) at 3 mA cm<sup>-2</sup>, 3 mAh cm<sup>-2</sup>.



**Fig. S13.** Cycle performance of the full cell at 1 C (200 mA g<sup>-2</sup>) with 5 mAh cm<sup>-2</sup> lithium inserted.

**Table S1.** Comparison of Li plating/stripping CE of various hosts

	Host Materials	Host Thickness ( $\mu\text{m}$ )	Electrolyte	Cycling Capacity (mAh $\text{cm}^{-2}$ )	Current Densities (mA $\text{cm}^{-2}$ )	Coulombic Efficiency	Cycles
This work	CNF-PI	160	1 M LiPF6 in EC/DEC/DMC + 10.0% FEC	3	1	97.5%	140
				3	3	96.2%	90
				5	3	96.6%	60
				10	5	96.5%	30
2017. Adv. Mater. <sup>1</sup>	Graphitized carbon fibers	1000	1 M LiTFSI in DOL/DME + 1% LiNO3	8	0.5	~98%	70
2017. Joule. <sup>2</sup>	Hollow carbon fiber	165	1 M LiTFSI in DOL/DME + 1% LiNO3	2	1	99.5%	240
2018. Adv. Energy Mater. <sup>3</sup>	N-doped graphene modified 3D porous Cu	70	1 M LiTFSI in DOL/DME + 1% LiNO3	2	1	97%	50
2018. Adv. Energy Mater. <sup>4</sup>	Porous poly-melamine-formaldehyde (PMF)	~200	1 M LiTFSI in DOL/DME	3	1	97.5	120
2018. Adv. Mater. <sup>5</sup>	Carbon nanotube	~80	1 M LiTFSI in DOL/DME	5	1	97.5	100
2018. Adv. Mater. <sup>6</sup>	Cu-CuO-Ni	~200	1 M LiTFSI in DOL/DME + 1% LiNO3	1	1	95%	250
2019. ESM. <sup>7</sup>	Gold nanoparticle-modified carbon paper	137.1	1 M LiTFSI in DOL/DME + 1% LiNO3	1	2	97.6%	100
2019. Adv. Mater. <sup>8</sup>	Cu nanowire	36.6	1 M LiTFSI in DOL/DME + 1% LiNO3	3	1	97.5%	60
2019. Nat. Comm. <sup>9</sup>	Al <sub>2</sub> O <sub>3</sub> -Ni-Au	70	1 M LiTFSI in DOL/DME + 1% LiNO3	2	0.5	97 %	350

### Supplementary References

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